

ABSTRACT OF THE DISCLOSURE

An IC socket is disclosed which facilitates automatic mounting of an IC package without a fear of lead terminal deformation and reduces the number of steps of assembling contacts into a socket body. The IC socket is an open top type IC socket which includes a socket body; and a cover member mounted vertically movable to the socket body to open and close contacts, wherein the socket body has a mounting portion on which to support an IC package mounted on the socket, and the cover member has a square opening facing the mounting portion and inclined guide wall surfaces leading to the opening and adapted to guide the mounted IC package onto the mounting portion.